IPC ASSOCIATION ELECTRONICS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserve international and Pan-American copyright conventions.		All rights reserved u	nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute								laterials and	rials and Mfg Information			
upplier	· Information													
ompany i	name*	Company unique ID			Ţ	Unique ID Authority				Response Date*				
onsemi											2023-06-06			
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-E	Env-Stewards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com			
uthorized	d Representative*	Title - Representative			I	Phone - Representative*			Email	Email - Representative*				
roduct-E	Env-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number	Mfr Iten	Mfr Item Number Mfr Item Nan		, LOW DROPOUT		Effective Date	Version	Manufacturing Si	te	Weight*	UOM	Unit Type	
		SCD33269T-5.0G 800 MA, 5 V, 1		800 MA, 5 V, LO			2023-06-06 CNC		CNC		1962.0	mg	Each	
	cturing Process Informa		Committee Dage	Aller	-STD-020 MS	YI Dating	Dook Droop	as Dody Tome	May Time at	Dook Tommo	Numb	on of Boflow Cw	olog	
	3 · · · · · · · · · · · · · · · · · · ·		Terminal Base Alloy J-STD-(CU Alloy NA			oL Kanng	Peak Process Body Temperature Max Time at Po		1.	k Temperature Number of Reflow Cycles seconds 3				
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	information regarding materia	1	1 6	2										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.55	mg	Supplier	Silicon (Si)	7440-21-3		3.55	mg
Die Attach	82.92	mg	A	Lead (Pb)	7439-92-1	7a	74.628	mg
			Supplier	Tin (Sn)	7440-31-5		8.292	mg
Lead Frame	1299.13	mg	Supplier	Silver (Ag)	7440-22-4		0.065	mg
			Supplier	Iron (Fe)	7439-89-6		1.2991	mg
			Supplier	Copper (Cu)	7440-50-8		1297.3372	mg
			Supplier	Phosphorus (P)	7723-14-0		0.4287	mg
Mold Compound-Black	543.9			Metal Hydroxide	proprietary data		40.7925	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		81.585	mg
			Supplier	Carbon Black (C)	1333-86-4		2.7195	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		375.291	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		43.512	mg
Plating	31.13	mg	Supplier	Tin (Sn)	7440-31-5		31.13	mg
Wire Bond - Cu	1.37	mg	Supplier	Copper (Cu)	7440-50-8		1.37	mg